



## C<sub>60</sub>/NiFe combination as a promising platform for molecular spintronics

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### ABSTRACT

Spintronics based on ferromagnetic metals and organic semiconductors has attracted great interest in recent years. Molecular-based spintronic devices, such as magnetic tunnel junctions, have been demonstrated with performances competing with those of conventional inorganic devices. Still, there is huge margin for improvement, as many details about the injection of spin-polarized electrons into the molecular layer remain not completely understood. In order to achieve better understanding and control of the physical mechanisms, it is necessary to explore various combinations of ferromagnetic metals and organic semiconductors.

In this letter, we study the properties of the combination between the ferromagnetic metal NiFe (commonly known as Permalloy or Py) and the molecular system C<sub>60</sub>. We produced C<sub>60</sub>/Py bilayers and characterized them structurally, electrically and magnetically. The C<sub>60</sub> films grow smoothly on both Py and SiO<sub>2</sub> substrates, and we estimate that a 5-nm-thick C<sub>60</sub> film covers completely the surface underneath without leaving pinholes and can be therefore used in a vertical device, as confirmed by electrical characterization. Furthermore, the C<sub>60</sub> film is robust against the deposition of the top metal electrode, being the intermixing layer of only 1–2 nm at the C<sub>60</sub>/Py interface. Finally, we show that the magnetic properties of Py are not affected by the deposition sequence, and that a 5-nm-thick Py layer on top of a C<sub>60</sub> layer keeps its magnetic properties intact.

These results show that the combination between Py and C<sub>60</sub> provides a robust template platform for the development of molecular spintronics, and can be used later on for more sophisticated investigations, such as the role of the interfaces in the spin injection.

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### 1. Introduction

π-Conjugated organic semiconductors have emerged recently as promising candidates for spintronic applications [1]. Most of the excitement about these materials comes from the fact that they present very weak mechanisms for spin scattering, mainly due to the majoritarian presence of light elements such as carbon, hydrogen and nitrogen.

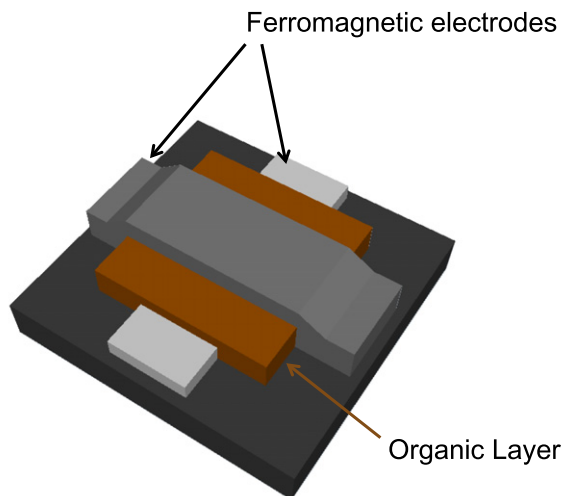
Indeed, organic spintronic devices have been demonstrated, very often in a vertical spin-valve geometry, in

which a molecular layer is sandwiched between two spin-polarized ferromagnetic (FM) metals (see Fig. 1 for a scheme of a typical spin valve). Spin polarized electrons are transported between the FM metals, and a clear difference in the electrical resistance of the device is measured depending on the relative alignment of the FM electrodes magnetization, being this magnetoresistance a proof of spin conservation across the molecular interlayer [2–8].

The performance of different devices, measured typically in terms of their magnetoresistance ratio, depends crucially on both the FM metal and the organic material employed [1] and also on microscopic details of the interface between them [2,9–11]. Several combinations of FM metals and organics have been investigated [12–19], but

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**Fig. 1.** Scheme of a typical organic spin valve with an organic layer sandwiched between two FM electrodes.

so far it has been challenging to predict the arising electrical performance only on the basis of the interface properties due to the complexity of the mutual interactions between so dissimilar materials.

Therefore, it would be of great importance to find a robust material combination to be used as a reliable template for molecular spintronics. This template would allow later on more sophisticated investigations, such as the role of the interfaces in the spin injection, or the injection of spin polarized electrons in molecules using alternative methods, employing for instance spin-filtering tunnel barriers [20] or ballistic electrons [21].

In this letter we show how the combination of Permalloy (Py;  $\text{Fe}_{81}\text{Ni}_{19}$ ) and  $\text{C}_{60}$  fullerene has several magnetic and structural properties that make it a promising test system for molecular spintronics. Permalloy was chosen because it is a well characterized 3d FM metal widely used in spintronic applications [22,23]. It is fairly resistant to oxidation and has a high Curie temperature ( $T_C = 830$  K), making it ideal for devices operating at room temperature. Moreover, it presents a very small magnetic anisotropy (so shape only can be used to engineer the macroscopic magnetic behavior) and a relatively high spin polarization (about 40%).

$\text{C}_{60}$  fullerene, one of the known allotropes of carbon with application in electronics, is attracting interest as well in the field of molecular spintronics [5,19,24,25], where  $\text{C}_{60}$ -based vertical spin-valves have already been reported [5]. In fact,  $\text{C}_{60}$  has some unique properties making it perfectly suited for spintronic application. First, it is composed by C-atoms only unlike most organic semiconductors that contain H atoms. The hyperfine interaction with H nuclei, which is one of the main sources of spin scattering for organic materials for OS [8], is therefore absent. Second, it can be evaporated in UHV conditions for a clean interfacing with metals. Finally, it is a standard and easily accessible molecule in high purity form, ideal for being employed as a platform for molecular spintronics.

## 2. Materials and methods

In the current study, Py/ $\text{C}_{60}$  bilayers were fabricated in situ in a dual chamber UHV evaporator with a base pressure below  $10^{-9}$  mbar. One chamber is dedicated to the Py deposition by means of electron-beam evaporation, while in the second one the  $\text{C}_{60}$  fullerene is thermally evaporated. High purity materials were employed: Py 99.95% purity (Lesker) and  $\text{C}_{60}$  99.9% (Sigma Aldrich). All the samples described were grown on Silicon substrates covered by a thin  $\text{SiO}_2$  native layer.

In order to characterize the structural and magnetic properties of the metal/fullerene system, we have fabricated two different sets of bilayers. In the first set, we deposited a bottom Py layer, with a fixed thickness of 5 nm, and subsequently a  $\text{C}_{60}$  layer with variable thickness (from 5 up to 25 nm) on top of it. In the second set, we reversed the deposition sequence and deposited a bottom 16-nm-thick  $\text{C}_{60}$  layer, covered in this case by a top Py layer with variable thickness (again in the range from 5 up to 25 nm). The samples of this second set were completed with the deposition of a 2 nm Al capping layer to prevent the oxidation of the Py layer.

The structural characterization of the samples was carried out by combining atomic force microscope (AFM) and X-ray reflectivity (XRR) measurements. AFM images were recorded in standard tapping mode with an Agilent microscope. X-ray reflectivity was performed in an X'Pert Panalytical system. The XRR data are analyzed with the software "Panalytical X'Pert Reflectivity", which allows the simulation and the fitting to experimental data of multilayer structures composed of different materials. A layer in the structure is defined by its thickness, density and roughness, which are free as fitting parameters.

Magnetic characterization was performed combining absolute magnetization and magneto-optical hysteresis loops. Magnetization was measured in a Quantum Design VSM-SQUID magnetometer, while magneto-optical data were recorded in a home-made magneto-optical Kerr effect (MOKE) apparatus [26].

For the electrical characterization, we produced vertical devices with a 20-nm-thick Py used as a top electrode above a variable-thickness  $\text{C}_{60}$  layer and a cobalt (Co) bottom electrode. A seed layer of aluminum oxide ( $\text{AlO}_x$ ) was inserted between the Co and the  $\text{C}_{60}$  layer. Further details on the fabrication of these specific devices are given elsewhere [5]. The electrical characterization was performed in a Lakeshore probe station at room temperature, using a 4-point configuration.

## 3. Results and discussion

For the growth of vertical spin valves with thin molecular layers sandwiched between two metallic contacts, some constraints need to be fulfilled by both the molecular and the metal layer:

- (1) The molecular layer needs to grow smoothly with low surface roughness, covering completely the bottom metal contact after the deposition of a few

monolayers. In this way, the metal film grown on top of the molecular layer would be in contact with the molecules only, without touching directly the metal underneath (pinholes). Furthermore, a low surface roughness is important to achieve homogeneous conductance through the molecular layer, since if the surface is very rough the current will flow mainly through those regions that present the lowest thickness.

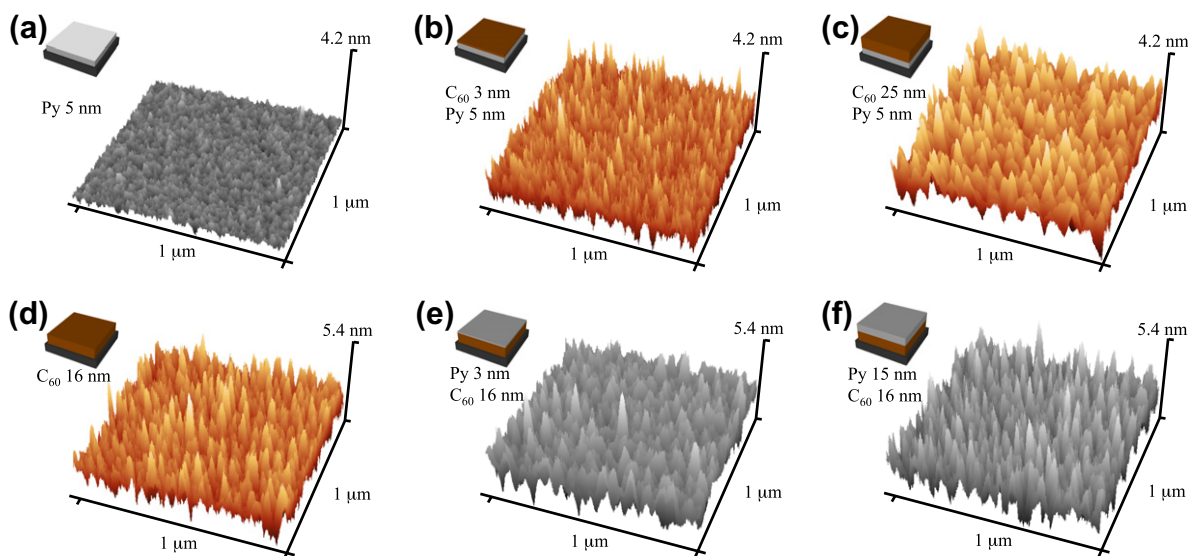
- (2) The top metal contact should not penetrate deeply in the organic layer during the deposition. Certain intermixing layer at the metal–organic interface is probably unavoidable [27–30], but it should be as thin as possible (in the order of 1 nm).
- (3) For being an optimal spin injector, the FM metal layers need to maintain their magnetic properties intact, either when they are deposited at the bottom or at the top of the vertical structure. In this article we show how the Py/C<sub>60</sub> system fulfills the three conditions listed above, making it a promising testing platform in molecular spintronics.

Starting from the morphological characterization, we summarize the surface information obtained by AFM in Fig. 2. Fig. 2a–c refers to the set of Py/C<sub>60</sub> samples in which Py is the bottom film and C<sub>60</sub> the top one.

Fig. 2a shows an AFM micrograph of a single 5-nm-thick Py film grown on the Si/SiO<sub>2</sub> substrate. The analysis indicates that the film is a polycrystal formed by flat nano-sized grains with an average lateral grain size ( $d$ ) of 15 nm. Its surface is extremely smooth, with a rms roughness ( $r$ ) of 0.19 nm across a  $1 \times 1 \mu\text{m}$  image (Fig. 1a). Fig. 2b shows the surface of a Py (5 nm)/C<sub>60</sub> (3 nm) bilayer. In this case, although the average lateral grain size of the topmost C<sub>60</sub> surface is also around 15 nm, as for the plain Py film, while the rms roughness is much higher being  $r = 0.43$  nm and

with a peak-to-peak value in excess of 3 nm (Fig. 2b). Comparing this roughness with the outer diameter of the C<sub>60</sub> molecule (diameter around 1 nm) we estimate the overall roughness to be about 3–4 molecular layers. The fact that the layer roughness is comparable with the layer thickness suggests that the coverage of the Py surface may be discontinuous. Therefore, such a thin C<sub>60</sub> layer is not suitable for the growth of a vertical device, as pinholes are very likely to form upon the deposition of a top metal contact. In the samples with thicker C<sub>60</sub> layers, the lateral grain size slightly increases reaching an average value  $d = 25$  nm for the 25-nm-thick film (a direct comparison can be done by inspection of Fig. 2b and c). However, the rms roughness of the C<sub>60</sub> layer surface does not change significantly with its thickness, as it maintains in the range  $r = 0.4$ – $0.5$  nm with peak-to-peak roughness in excess of 3 nm (Fig. 2b and c). Given these rms and peak-to-peak roughnesses, we estimate that a 5-nm-thick C<sub>60</sub> film forms a continuous layer on the metal surface, and hence it could be used as interlayer in a vertical device.

We can turn out now our attention to the topography of the Py films grown over a fullerene underlayer (Fig. 2d–f). A 16-nm-thick C<sub>60</sub> layer deposited directly on the substrate is shown in Fig. 2d. This layer is formed by grains with an average lateral size of 20 nm, in good agreement with AFM data reported in literature [31]. In this case, the rms roughness is  $r = 0.65$  nm, with the peak-to-peak roughness in excess of 3.5 nm. This peak-to-peak roughness shows that the morphology of the surface of the C<sub>60</sub> layers is substantially independent of the substrate utilized, either SiO<sub>2</sub> or Py. When a Py layer is subsequently grown on top of the 16-nm-thick C<sub>60</sub> film, its surface morphology mimics that of the C<sub>60</sub> layer underneath, both in terms of grain size and of surface roughness, irrespectively of the Py thickness. The peak-to-peak roughness value of  $\sim 3$ – $3.5$  nm sets the limiting thickness required for obtaining a continuous



**Fig. 2.** AFM characterization of Py/C<sub>60</sub> and C<sub>60</sub>/Py bilayers. Py surfaces are shown in grey scale, C<sub>60</sub> surface in brown scale. (a–c) Images of samples Py/C<sub>60</sub>, Py below C<sub>60</sub>: (a) surface of a 5 nm Py layer with no top C<sub>60</sub>; (b) 5 nm Py covered by 3 nm C<sub>60</sub>; (c) 5 nm Py covered by 25 nm C<sub>60</sub>. (d–f) Images of samples C<sub>60</sub>/Py, with C<sub>60</sub> below Py: (d) surface of 16 nm C<sub>60</sub> with no top Py; (e) 16 nm C<sub>60</sub> covered by 3 nm Py; (f) 16 nm C<sub>60</sub> covered by 15 nm Py.

layer both in the Py and C<sub>60</sub> case. For the case of a thin Py layer (thickness <4 nm), its discontinuous film structure will be confirmed by the magnetic characterization of the samples (see below).

In addition to AFM, we have also used X-ray reflectivity (XRR) to check the layer thickness and homogeneity on a larger scale (mm<sup>2</sup> compared to μm<sup>2</sup> for the AFM analysis). Interference fringes (also called Kiessig or Laue fringes) are present in XRR scans on both single Py and C<sub>60</sub> layers of similar thickness (Fig. 3a and b), confirming the high quality of the surfaces under study. In the particular case of a single Py film, the fringes pattern extend up to an angle of 3°, while in a single C<sub>60</sub> layer they are no longer discernible from the noise background above 1.5°. This fact indicates that the large area roughness of Py is lower than for the C<sub>60</sub>, in good agreement with the AFM measurements (see above). In particular, from the XRR fittings we extract a large area roughness of  $r = 0.4$  nm (for the Py film) and  $r = 1.4$  (for the C<sub>60</sub> film).

Following the overall analysis of both AFM and XRR data, we can conclude that the Py/C<sub>60</sub> system fulfills the first condition listed above for a material to become a suitable test platform for molecular spintronics.

We move now into condition two of the criteria outlined above. To this purpose, information on the damage caused to the molecular layer by the top metal deposition can be obtained by comparing XRR scans taken from a molecular layer before and after the deposition of a top metal layer [32]. The procedure applied is as follows: we first measured a XRR scan on a single C<sub>60</sub> layer deposited on top Si/SiO<sub>2</sub> (Fig. 3b). Afterwards, we placed the very same sample back in the evaporation chamber and deposited on top 8-nm-thick Py layer. The XRR scan measured on the full bilayer after the metal deposition is shown in Fig. 3c.

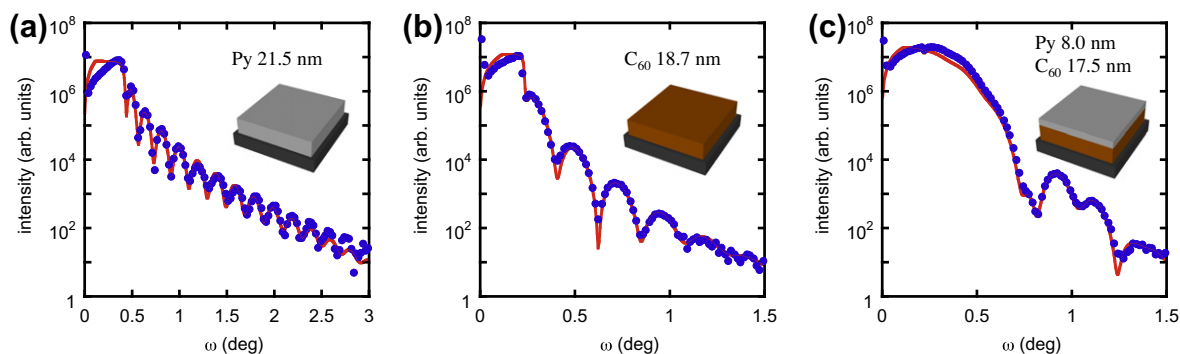
The fit to the data shown in Fig. 3b (red line) provides us with values of the layer thickness (18.7 nm), roughness (1.4 nm) and density (1.6 g/cm<sup>3</sup>). These values were obtained by using as starting parameters in the fitting procedure the nominal thickness given by a thickness monitor during the deposition (20 nm), the roughness obtained by AFM measurements (0.65 nm), and the C<sub>60</sub> nominal density (1.6 g/cm<sup>3</sup>). In the case of the fit to the XRR data of the C<sub>60</sub>/Py bilayer (Fig. 3c, red line), the starting parameters

for the C<sub>60</sub> layer are the values provided by the fit of the uncovered layer, while for the Py we used the nominal thickness (8 nm) and the nominal density (8.72 g/cm<sup>3</sup>). From the fit, we obtain for the C<sub>60</sub> layer the same density (1.6 g/cm<sup>3</sup>) and for the Py layer a density (8.8 g/cm<sup>3</sup>) and a thickness (7.8 nm) in good agreement with the expected values. Interestingly, we find that the C<sub>60</sub> thickness diminished from 18.7 nm down to 17.5 nm after the top metal deposition. We can assume that after the metal deposition on the fullerene, exactly at the C<sub>60</sub>/Py interface, an ill-defined layer with a thickness of approximately 1–2 nm is formed. The thickness of this layer is extremely thin compared to the damage reported to other molecular layers after a metal deposition [6,29,30].

From the data presented above we prove that the C<sub>60</sub>/Py system fulfills as well the second condition proposed above (thin intermixing layer, in the order of 1 nm) for making it a suitable metal–organic reference system for molecular spintronics.

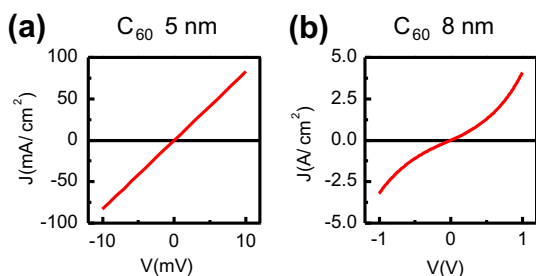
From the above discussion, the 5-nm-thick C<sub>60</sub> layer would seem to be the limiting case between a short-circuited and a resistive vertical device, because 5 nm is just above the sum between the fullerene layer roughness and the interfacial ill-defined layer. Indeed, this fact is confirmed by the electrical characterization of devices where the Py layer is used as a top electrode. We produced vertical spin valves with the same geometry of Fig. 1, employing a Co/AlO<sub>x</sub> bottom electrode, and a Py top electrode [5].

The thickness of the Py layer was kept fixed to 20 nm, while different C<sub>60</sub> layer thicknesses were employed in different devices. For the 3-nm-thick C<sub>60</sub> layer, we measured a very low resistance area product ( $RA < 10^{-4} \Omega/\text{cm}^2$ ), most probably due to pinholes in the C<sub>60</sub> layer that short-circuit the device. This suggestion is supported by the fact that the thickness of the C<sub>60</sub> is lower than the sum between the roughness and the ill-defined interfacial layer. On the contrary, for the 5-nm-thick C<sub>60</sub> layer, the device was not short-circuited, as shown in Fig. 4a. The resistance area product in this device is  $RA = 10^{-2} \Omega/\text{cm}^2$ , 2 orders of magnitude higher than the 3-nm-thick C<sub>60</sub> device. However, the device gets short-circuited when a rather low voltage is applied to it (0.2 V), probably due to the high current density. An 8-nm-thick C<sub>60</sub> layer device is more resistive ( $RA = 50 \Omega/\text{cm}^2$ ) and more stable (up to



**Fig. 3.** X-ray reflectivity characterization of Py/C<sub>60</sub> layers. Experimental data are shown as blue dots; the red line is the fit obtained by modeling the sample as (a) a single Py layer, (b) a single C<sub>60</sub> layer, (c) a C<sub>60</sub>/Py bilayer. The thicknesses displayed in the figure are those obtained from the fit. (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)





**Fig. 4.** Electrical characterization of vertical devices with variable-thickness  $C_{60}$  interlayers and Py top electrodes: current density vs applied voltage measured in a 5-nm-thick  $C_{60}$  layer (a) and a 8 nm-thick  $C_{60}$  layer (b).

1 V, Fig. 4b), confirming that 5 nm is around the limiting case between a short-circuited and a stable resistive device.

After having discussed the morphological and electrical properties of the Py and fullerene layers, we should turn now our attention to the magnetic properties of the metal film (see condition three above). It is clear that for producing optimum spin valves, the Py layer must conserve its magnetic properties unaltered when deposited either below or above a molecular layer.

It is generally expected that a molecular layer deposited on top of a FM metal would not affect dramatically the magnetic properties of the latter, although issues such as oxidation or a strong metal-molecular bonding have to be taken into account carefully [2,10]. For the opposite case, that is a FM layer on top of a molecular one, it is not obvious to what extent the roughness of the molecular sub-layer affects the magnetic properties of the FM film [16–18]. In particular, the magnetic properties of the ill-defined layer at the interface need to be investigated.

The characterization of the magnetic properties of the different Py films has been done focusing on the two most representative parameters that define the magnetic hysteresis loop: the saturation magnetization ( $M_s$ ) and the coercive field ( $H_c$ ). For the first set of samples, in which  $C_{60}$  layers of different thicknesses cover a 5-nm-thick Py film, the  $M_s$  values are displayed with blue closed symbols and line in Fig. 5a. From the inspection of Fig. 5a we can conclude that the  $M_s$  values of the Py underlayer are not affected by the growth of the top  $C_{60}$  layer:  $M_s$  is constant within the error bars, irrespective of the amount of molecules deposited on top of the Py underlayer. Note that the first blue symbol corresponds to a  $C_{60}$  thickness equal to 0, so it represents the  $M_s$  of a Py film grown directly on Si/SiO<sub>2</sub>.

The red open symbols and line in Fig. 5a refer to the  $M_s$  for the inverse set of samples in which different thicknesses of Py are deposited on top of the  $C_{60}$  underlayer. In this case, we find that the samples with Py thicknesses above 3 nm have again  $M_s$  constant within the error bar, with a value which is very close to the  $M_s$  measured for the previous samples. The 3-nm-thick Py layer (first red open symbol in Fig. 5a) shows a remarkably different behavior. It is ferromagnetic, because it displays a clear hysteresis loop, but its  $M_s$  value of  $270 \pm 20$  emu/cm<sup>3</sup>

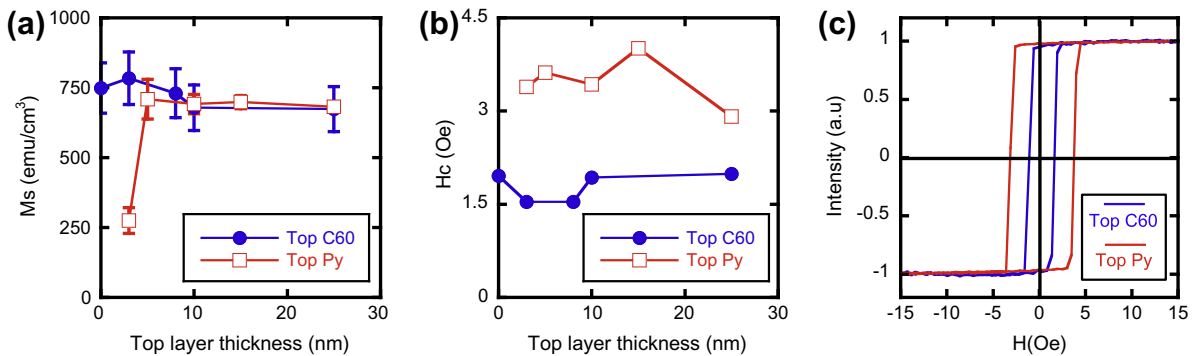
corresponds to almost one third of the average  $M_s$  of the other samples. This considerable drop in  $M_s$  of this ultra-thin layer can be explained considering that (1) the  $C_{60}$  surface peak-peak roughness is in the order of the Py thickness, so the layer may be not continuous (see above the discussion about the morphological properties of the Py/ $C_{60}$  system); (2) the thickness of the ill-defined layer between  $C_{60}$  and Py that we estimated in approximately 1–2 nm corresponds to almost one half of the Py layer thickness. In summary, the data displayed in Fig. 5a points to 5 nm as the lowest thickness of a Py overlayer to be continuous and with bulk magnetic properties.

In general, all our Py samples show a value for  $M_s$  of  $720 \pm 70$  emu/cm<sup>3</sup>, which is slightly lower than the reported saturation value for bulk Py ( $830$  emu/cm<sup>3</sup>) [33] and resulting closer to the  $M_s$  of pure Ni. Such a difference may be due to two concomitant factors. In the first place, the stoichiometry of the NiFe alloy is not conserved during the e-beam evaporation, with an effective lower Fe concentration in the film as observed by Energy Dispersive X-ray analysis (not shown). In the second place, the Fe could get oxidized to some minor extent during the deposition process, even if the pressure in the chamber during the metal deposition was around  $10^{-7}$  mbar. In both cases the  $M_s$  would deviate from the standard Py saturation and move to a value closer to the pure Ni saturation magnetization ( $488$  emu/cm<sup>3</sup>) [33].

Additional hints about the magnetic properties of the different Py films in combination with  $C_{60}$  are provided by the values of the coercive field  $H_c$ , which gives us information regarding the relation between the external applied magnetic field and the energy required for reversing the magnetization direction.

In Fig. 5b, we show with blue and red symbols the  $H_c$  of the bilayers with the magnetic Py films placed as bottom or as top electrode, respectively. We must point out here that all our Py films show a weak uniaxial magnetic anisotropy, probably due to a small remnant field at the sample stage during the deposition. Therefore, in Fig. 5b we include only the  $H_c$  values measured along the direction of easy magnetization (easy-axis) for a consistent comparison between different samples. Fig. 5b shows that the  $C_{60}$  grown on top of the Py film has not any influence on its hysteresis loop. The coercive fields recorded are all in the range from 1.5 to 2 Oe, which are very close to the value obtained in the case of a plain Py film without any  $C_{60}$  above (first blue point in Fig. 5b). The average coercive field increases to 3.5 Oe for the Py films grown on top of  $C_{60}$ . This difference can be also visualized in Fig. 5c, which shows the hysteresis loop of a 5 nm Py layer placed as top and bottom electrode (blue and red curve, respectively). The significant difference in  $H_c$  is due to the intrinsic roughness of the underlying  $C_{60}$  layer (see above), which creates magnetic pinning sites (orange-peel like effect [34]) in the top Py film [16–18]. In any case, although the difference in the coercive field of the two cases is proportionally very large, its absolute value remains very small. In conclusion, the magnetic properties of the Py layer are not drastically affected by the  $C_{60}$  underneath.

Following the magnetic characterization performed in the Py/ $C_{60}$  system, we can now assure that such combina-



**Fig. 5.** Magnetic characterization of C<sub>60</sub>-Py bilayers. Magnetization and coercive field are shown for two sets of samples: in the first set, Py layers of fixed thickness (5 nm) are covered by C<sub>60</sub> layers with variable thickness; in the second set, C<sub>60</sub> layers of fixed thickness (16 nm) are covered by Py layers with variable thickness. For the first sample set,  $M_s$  and  $H_c$  are plotted as a function of the thickness of the top C<sub>60</sub> layer (blue closed data in (a) and (b), respectively). For the second set,  $M_s$  and  $H_c$  are plotted as a function of thickness of the top Py layer (red open data in a and b respectively). The main error source comes from the thickness of the FM layer, which we estimate in 0.5 nm. (c) Shows the hysteresis loop of a 5-nm-thick Py when it is placed below a 8 nm C<sub>60</sub> film (blue closed circles) and above a 16-nm-thick C<sub>60</sub> film (red open squares). (For interpretation of the references to colour in this figure legend, the reader is referred to the web version of this article.)

tion of materials fulfills as well the third condition for an ideal materials test system in molecular spintronics outlined above.

#### 4. Conclusion

In this letter, we characterized structurally, electrically and magnetically C<sub>60</sub>/Py bilayers combining different techniques (AFM, XRR, SQUID, MOKE) in order to test their suitability as a base system for molecular-based spintronics. We have highlighted three general constraints that any bilayer needs to fulfill for being used in vertical spintronic devices: (1) the films need to grow smoothly; (2) the molecular layer should be minimally damaged by the top metal deposition; (3) the magnetic properties of the ferromagnetic layer need to be preserved.

We found that the C<sub>60</sub>/Py bilayers satisfy these three constraints: the layers grow with low surface roughness and the intermixing between Py and C<sub>60</sub> layers is limited to 1–2 nm, so that a 5-nm-thick C<sub>60</sub> layer can be contacted without pinholes. Finally, a Py layer as thin as 5 nm already displays good magnetic properties even when it is grown on the rough C<sub>60</sub> surface.

We can, thus, conclude that the combination between C<sub>60</sub> and Py provides a robust platform for spintronic application. In particular, we suggest that this system is ideal to study the effect of further modifications (of the morphology and/or of the energetic) of the metal–organic interface.

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